Connector for SD Memory Card

SCDA Series



Compact low-profile type with highly reliable contact structure.

For SD Memory Card

For microSD™ Card

For SIM Card 8pins

For Memory Stick Micro™

Combine Type

For W-SIM



Typical Specifications

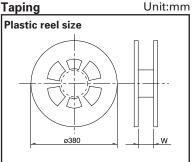
Typical Opecinications							
Items			Specifications				
Applical		media	SD Memory Card/ MultiMediaCard™				
Structure	Mounting type		Surface mounting type				
Structure	Mounting style		Standard mount/Reverse mount				
	Media ejection structure		Push-push type				
	Operating temperature range		−25°C to +60°C				
Performance	Voltage proof		100V AC 1minute				
	Insulation resistance (Initial)		1,000MΩ min.				
	Contact resistance (Initial)	Connector contacts	100mΩ max.				
		Detection switch	500mΩ max.				
	Insertion and removal cycle		10,000cycles				

Product Line

Media ejection structure	Mounting style	Features	Stand-off (mm)	Packing system	Product No.	Drawing No.
Push-push type	Standard mount	Inner tail, card eject stroke 5mm	0		SCDA9A0400	1
		Inner tail, card eject stroke 8mm			SCDA8A0201	2
					SCDA7A0101	3
		Outer tail, card eject stroke 8mm	1.5	Taping	SCDA7A0200	4
			1.8		SCDA7A1201	5
	Reverse mount	Outer tail	0		SCDAAA0100	6
		Outer tall	1.8		SCDAAA0601	7



Packing Specifications



Product	Number of packages (pcs.)			width	Tape width	Export package	
No.	1 reel	1 case /Japan	1 case /export packing	W (mm)	(mm)	measurements (mm)	
SCDA7A0101	400	800	1,600				
SCDA7A0200	250	500	1,000				
SCDA7A1201	300	600	1,200	45.5			
SCDA8A0201	400	400 800	1,600		44	403×403×249	
SCDA9A0400	400	800					
SCDAAA0100	500	1,000	2,000				
SCDAAA0601	300	600	1,200				

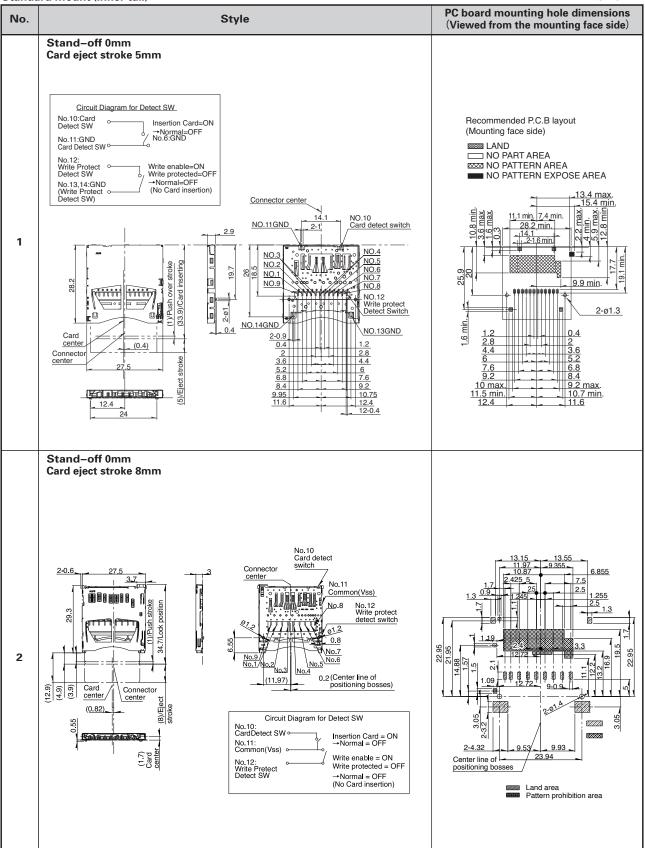
Note

Please place purchase orders per minimum order unit N (integer).

Dimensions

Standard mount (Inner tail)

Unit:mm



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Dimensions Standard mount

Unit:mm

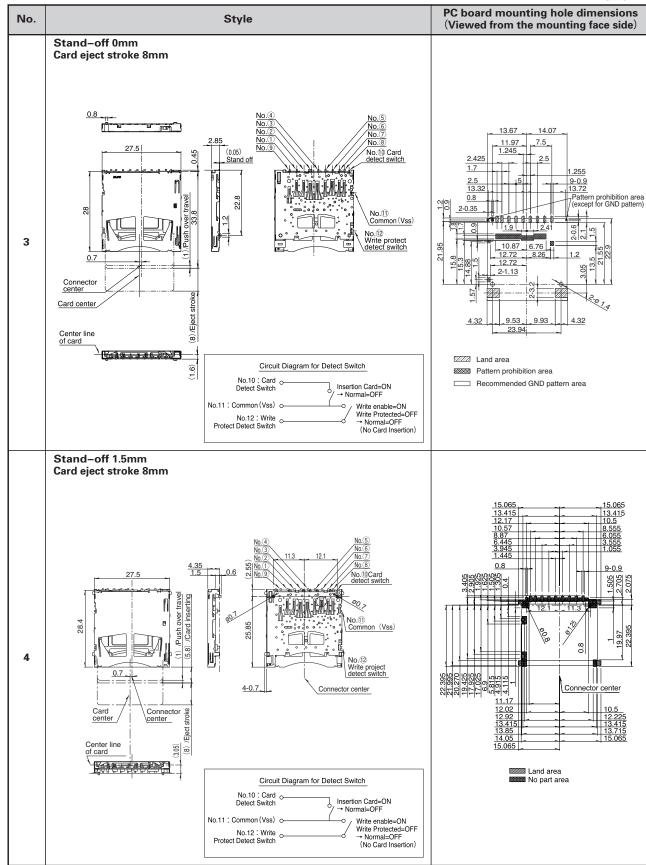
For SD Memory Card

For microSD™ Card

For SIM Card 8pins

Memory Stick Micro™

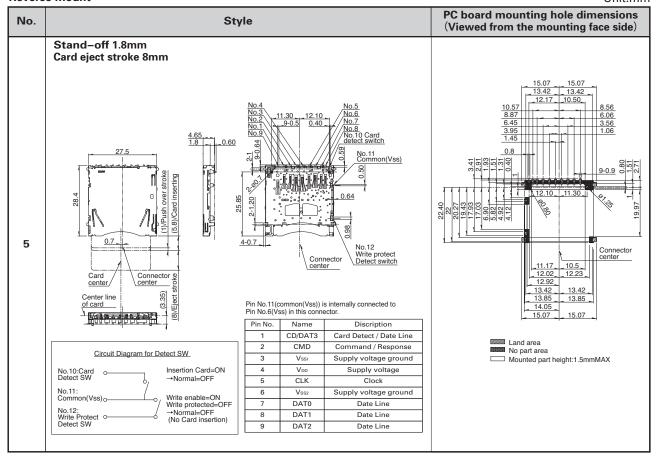
Combine Type





Dimensions Reverse mount

Unit:mm





For microSD™ Card

For SIM Card 8pins

For Memory Stick Micro™

Combine Type



Dimensions **Reverse mount**

Unit:mm

For SD Memory Card

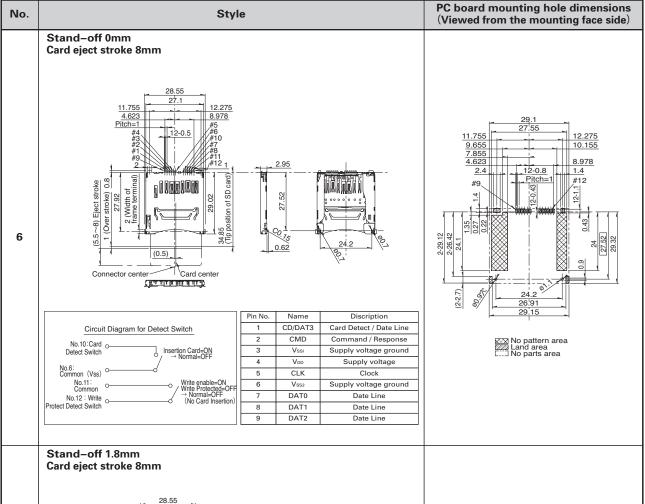
For microSD™ Card

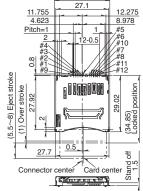
For SIM Card 8pins

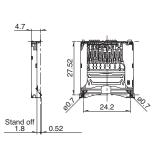
Memory Stick Micro™

Combine Type

For W-SIM

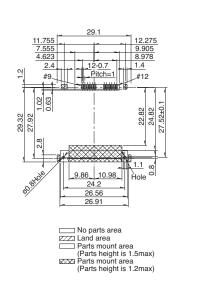






		Circuit Diagram for Detect Switch
Automotive Jse		No.10∶Card ODetect Switch Insertion Card=ON → Normal=OFF
		No.6: Common (Vss)
		No.11: Write enable=ON Write Protected=OFF No.12: Write O
		Protect Detect Switch

Pin No	э.	Name	Discription			
1	(D/DAT3	Card Detect / Date Line			
2		CMD	Command / Response			
3		Vssı	Supply voltage ground			
4		V _{DD}	Supply voltage			
5	5 CLK		Clock			
6	6 Vss2		Supply voltage ground			
7	7 DAT0		Date Line			
8	8 DAT1		Date Line			
9		DAT2	Date Line			
9		DAT2	Date Line			





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List of Varieties

For SD Memory Card

For microSD™ Card

For SIM Card 8pins

For Memory Stick Micro™

Combine Type

For W-SIM

Applicable media	Product No.	Photo	Media ejection structure	Mounting style	Features	Stand-off (mm)	Auto motive use	Page
	SCDA9A0400				Inner tail Card eject stroke 5mm	0	_	
	SCDA8A0201			Standard	Inner tail Card eject stroke 8mm			
	SCDA7A0101			mount	Card eject stroke 8mm			
SD Memory Card	SCDA7A0200					1.5		527
Multi-MediaCard™	SCDA7A1201	1				1.8		527
	SCDAAA0100	C. Marino	Push-push type	Reverse	Outer tail	0		
	SCDAAA0601			mount		1.8		
	SCHA4B0100			Standard mount	With switch		0	
	SCHA4B0400				With switches and fly-out protection.		_	532
	SCHA5B0200			Reverse mount	With switch		0	
microSD™	SCHB1A0205				Hinge cover type Without switch	0		535
Card	SCHB1B0100	1000	Manual insertion/ removal	Standard	Hinge cover type With switch			
	SCHD1A0101			mount	Header type		_	537
	SCHD3A0100				7,7			
	SCHH1D0100				Adapter			539

Note

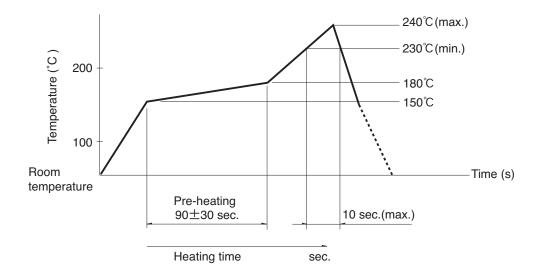


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Soldering Conditions

Example of Reflow Soldering Condition (Reference)

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2ϕ CA (K) or CC (T) at soldering portion.
- 3. Temperature profile



Please refer to each product's specification sheet to confirm temperature profile.

Cautions for using this product

- 1.Connector hamdling precautions
- (1) Safeguard the connector assembly against flux penetration from its top side.
- (2) This product is designed on the assumption that they will not be washed after soldering.

If youwash it, it may be cause deterioration of mechanically and electrically.

If washing is necessary, pleasemake contact with us beforehand.

When soldering terminals, there is a danger that load placed on the terminals may cause rattle, deformation or electrical degradation to occur depending on the conditions.

Caution is therefore required.

3. When soldering, do not use water soluble flux because this may corrode the product.

4.regarding the setting of reflow conditions, please confirm them with the actual mass production conditions.

5.As P.W.B. warping may alter characteristics, please take this into consideration when designing pattern and layout.

6.Please do not solder at the ejector pushing position.

- 7.To prevent contact disturbance by the sulfuration or oxidation of the conyact and terminal, and deterioration of solder ability by thin film on the terminal, please note following.
- Storage in the atmosphere of high temperature at 60 degrees or more, high humidity, corrosive gases such as sulfur or chlorinate gas, and excessive piling up of the carton boxes shall be avoided.
- Connectors shall be stored as the package not opened and in the normal temperature and normal humidity, and the connectors shall be used preferably within 3 months, at least within 6 months.
- When the connectors are stored after opening the package, the connectors shall be sealed with a polyethylene bag
 etc. and stored in dark and cool place, avoiding direct sunlight. Bag etc. and stored in dark and cool place, avoiding
 direct sunlight. The connectors shall be used as soon as possible.
- 8.Don't push or hold down the metal cover of the connector, otherwise there is a possibolity that the card would not be ejected or influences to other function.
- 9.Please attention following items to prevent connector from miss operation, such as bounding caused by ON/OFF switching and chattering by vibration.
- Repeated reading/writing.
- · Establish delay time-recommended 400msec min.
- Establish CR accumulation circuit.
- 10. This product does not operate normally when the card which does not conform to the specification is used occasionally.

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Combine Type

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

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